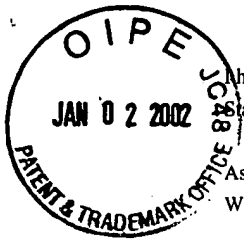


#4/ PRE AMOT
A.
1-18-02
Inventor
PATENT



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JAN - 4 2002

TC 2830 MAIL ROOM

On 10/31/01

TOWNSEND and TOWNSEND and CREW LLP

By: [Signature]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sien G. Kang et al.

Application No.: 09/893,340

Filed: June 26, 2001

For: SURFACE FINISHING OF SOI
SUBSTRATES USING AN EPI
PROCESS

Examiner: Unassigned

Art Unit: 2813

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Prior to examination of the above-referenced application, please enter the following amendments and remarks.

IN THE SPECIFICATION:

On page 1, please add the following paragraph after the title of the invention:

-- This is a continuation of U.S. Patent Application No. 09/399,985, filed on September 20, 1999, now U.S. Patent No. 6,287,941, which claims priority to U.S. Provisional Patent Application No. 60/130,423, filed on April 21, 1999, which are incorporated by reference herein for all purposes. --

A1